

ABSOLUTE MAXIMUM RATINGS

(Note 1)

Supply Voltage (V_{CC})	–0.3 to 44V
SENSE, PWRGD	–0.3 to 44V
GATE	–0.3 to 50V
FB, UV, OPEN	–0.3 to 44V
OV	–0.3 to 18V
RETRY	–0.3 to 15V
TIMER	–0.3V to 4.3V
Maximum Input Current (TIMER)	100 μ A
Operating Temperature	
LT4254C	0°C to 70°C
LT4254I	–40°C to 85°C
Storage Temperature Range	–65°C to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

<p>TOP VIEW</p> <p>GN PACKAGE 16-LEAD PLASTIC TSSOP $T_{JMAX} = 125^{\circ}\text{C}$, $\theta_{JA} = 130^{\circ}\text{C/W}$</p>	<p>ORDER PART NUMBER</p> <p>LT4254CGN LT4254IGN</p> <p>GN PART MARKING</p> <p>4254 4254I</p>
<p>Order Options Tape and Reel: Add #TR Lead Free: Add #PBF Lead Free Tape and Reel: Add #TRPBF Lead Free Part Marking: http://www.linear.com/leadfree/</p>	

Consult LTC Marketing for parts specified with wider operating temperature ranges.
Note: NC = No Connect

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}\text{C}$. $V_{CC} = 24\text{V}$ unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V _{CC}	Operating Voltage		●	10.8		36	V
I _{CC}	Operating Current				1.9	3	mA
UV _{LH}	Undervoltage Threshold	V _{CC} Low-to-High Transition	●	3.96	4	4.04	V
V _{UVHYS}	Hysteresis			0.25	0.4	0.55	V
I _{INUV}	UV Input Current	UV = 4.5V UV = 0V			−0.1 −1.5	−1 −3	μA μA
VO _{VHL}	Overvoltage Threshold	V _{CC} Low-to-High Transition	●	3.96	4	4.04	V
VO _{VHYS}	Hysteresis			0.25	0.4	0.55	V
I _{INOV}	OV Input Current	0V ≤ OV < 6.5V			0.1	1	μA
V _{OPEN}	Open-Circuit Voltage Threshold (V _{CC} − V _{SENSE})		●	2	3.5	5	mV
VO _{LOPEN}	OPEN Output Low Voltage	I _O = 2mA I _O = 5mA			0.20 0.75	0.5 1.3	V V
I _{INOPEN}	Leakage Current	V _{OPEN} = 5V			0.1	1	μA
V _{SENSETRIP}	SENSE Pin Trip Voltage (V _{CC} − V _{SENSE})	FB = 0V FB ≥ 2V	● ●	5.5 40	12 50	25 60	mV mV
I _{INSNS}	SENSE Pin Input Current				40	70	μA
I _{PU}	GATE Pull-Up Current	Charge Pump On, ΔV _{GATE} = 7V	●	−15	−35	−63	μA
I _{PD}	GATE Pull-Down Current	Any Fault, V _{GATE} = 3V		40	60	80	mA
ΔV _{GATE}	External N-Channel Gate Drive (Note 2)	V _{GATE} − V _{CC} , 12V ≤ V _{CC} ≤ 20V 20V ≤ V _{CC} ≤ 36V	● ●	4.5 10	8.8 11	12.5 12.5	V V
V _{FB}	FB Voltage Threshold	FB High-to-Low Transition FB Low-to-High Transition	● ●	3.96 4.20	4 4.45	4.04 4.65	V V
V _{FBHYS}	FB Hysteresis Voltage			0.3	0.45	0.60	V
V _{OLPGD}	PWRGD Output Low Voltage	I _O = 1.6mA I _O = 5mA			0.25 0.63	0.4 1.0	V V

ELECTRICAL CHARACTERISTICS

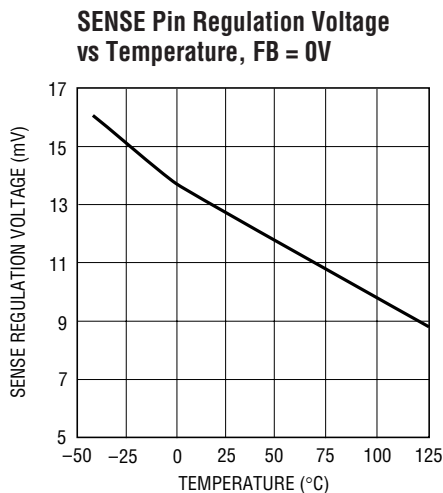
The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{CC} = 24\text{V}$ unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
I_{PWRGD}	PWRGD Pin Leakage Current	$V_{PWRGD} = 36\text{V}$		0.1	10	μA
I_{INFB}	FB Input Current	$\text{FB} = 4.5\text{V}$	-1	-0.1		μA
$I_{TIMERPU}$	TIMER Pull-Up Current		● -60	-120	-180	μA
$I_{TIMERPD}$	TIMER Pull-Down Current		● 1	3	5	μA
$V_{THTIMER}$	TIMER Shut-Down Threshold Voltage	$C_{TIMER} = 10\text{nF}$	● 4.3	4.65	5	V
D_{TIMER}	Duty Cycle (RETRY Mode)		● 1.5	3	4.5	%
$V_{RETRY(TH)}$	RETRY Threshold		● 0.4	0.8	1.2	V
I_{INRTR}	RETRY Input Current	$\text{RETRY} = \text{GND}$	-120	-85	-40	μA
t_{PHLUV}	UV Low to GATE Low	$C_{GATE} = 100\text{pF}$		1.7		μs
t_{PLHUV}	UV High to GATE High	$C_{GATE} = 100\text{pF}$		6		μs
t_{PHLFB}	FB Low to PWRGD Low			0.8		μs
t_{PLHFB}	FB High to PWRGD High			3.2		μs
$t_{PHLSENSE}$	$(V_{CC} - V_{SENSE})$ High to GATE Low	$V_{CC} - V_{SENSE} = 275\text{mV}$		2.5	4	μs

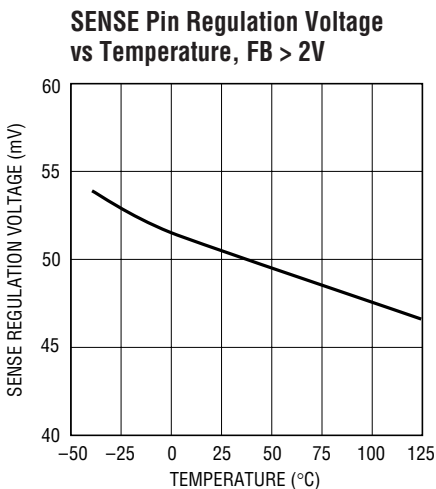
Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: An internal clamp limits the GATE pin to a maximum of 11V above V_{CC} (under normal operating conditions). Driving this pin to a voltage beyond the clamp voltage may damage the part.

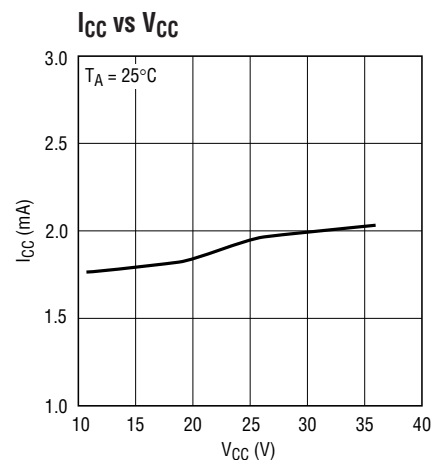
TYPICAL PERFORMANCE CHARACTERISTICS



4254 G01



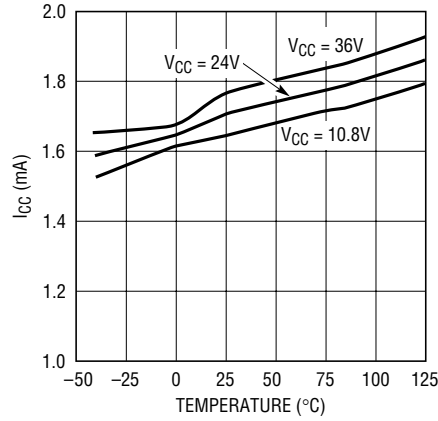
4254 G02



4254 G03

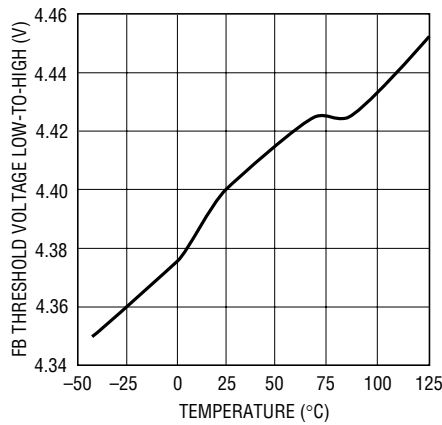
TYPICAL PERFORMANCE CHARACTERISTICS

I_{CC} vs Temperature



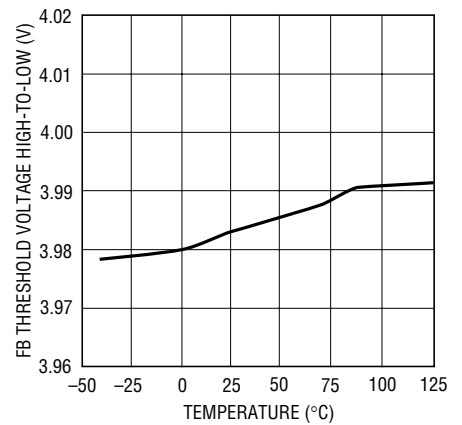
4254 G04

FB Pin Threshold Voltage (Low-to-High) vs Temperature



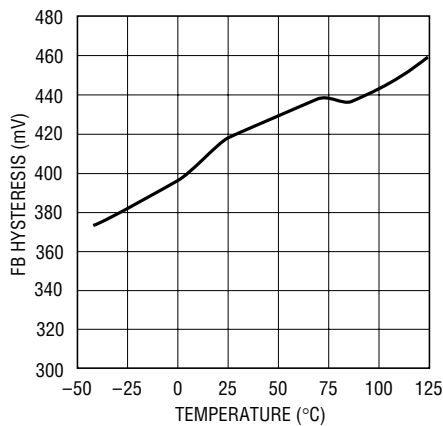
4254 G05

FB Pin Threshold Voltage (High-to-Low) vs Temperature



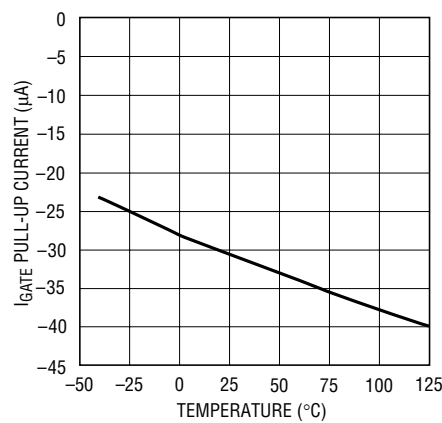
4254 G06

FB Pin Hysteresis vs Temperature



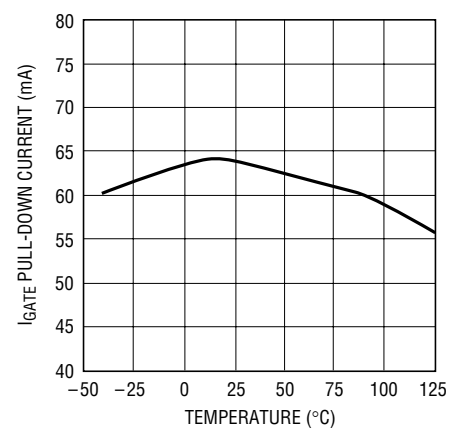
4254 G07

GATE Pin Pull-Up Current vs Temperature



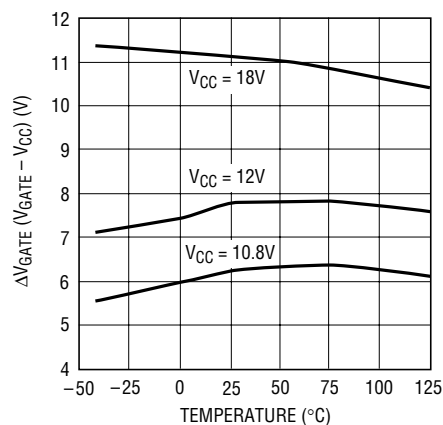
4254 G08

GATE Pin Pull-Down Current vs Temperature



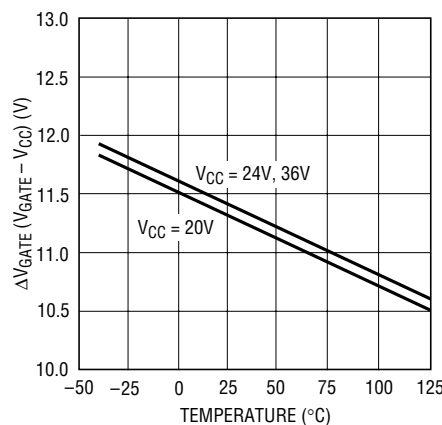
4254 G09

ΔV_{GATE} vs Temperature



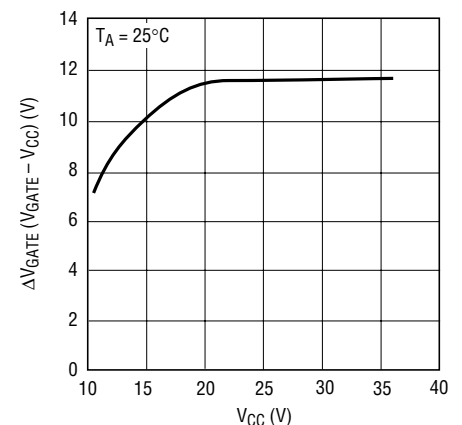
4254 G10

ΔV_{GATE} vs Temperature



4254 G11

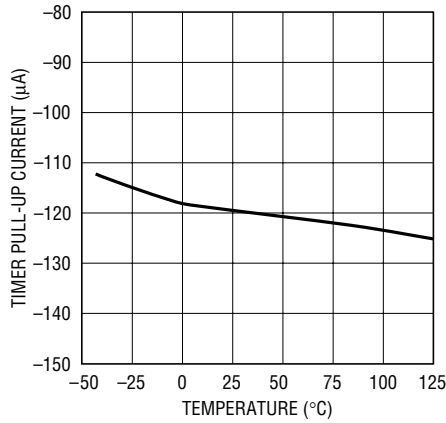
ΔV_{GATE} vs V_{CC}



4254 G12

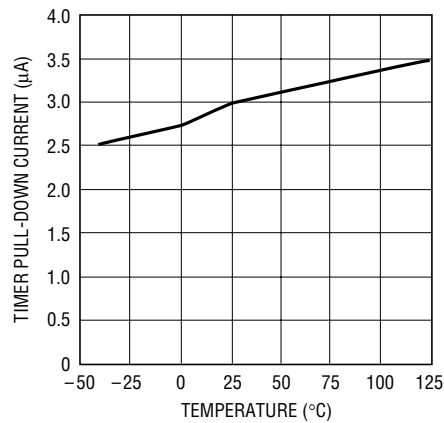
TYPICAL PERFORMANCE CHARACTERISTICS

TIMER Pin Pull-Up Current vs Temperature



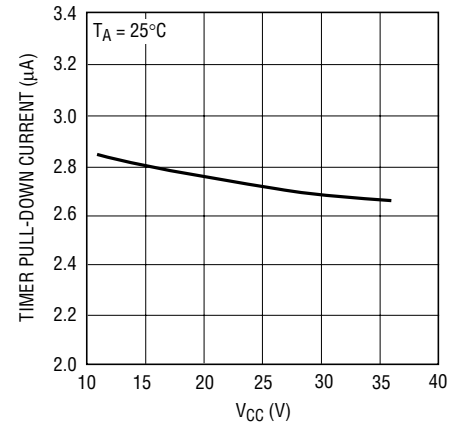
4254 G13

TIMER Pin Pull-Down Current vs Temperature



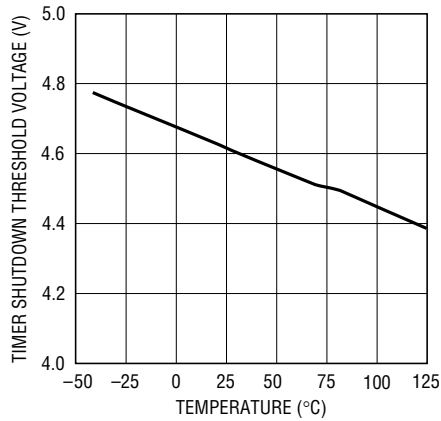
4254 G14

TIMER Pin Pull-Down Current vs V_{CC}



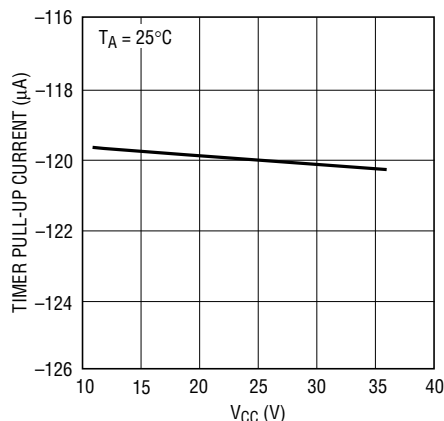
4254 G15

TIMER Shutdown Threshold vs Temperature



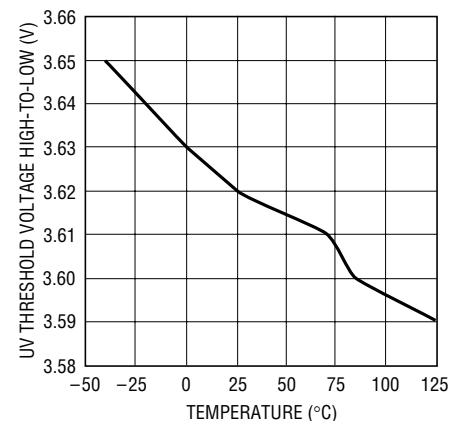
4254 G16

TIMER Pin Pull-Up Current vs V_{CC}



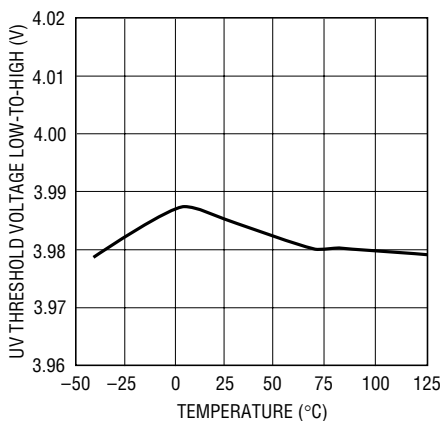
4254 G17

UV Threshold Voltage (High-to-Low) vs Temperature



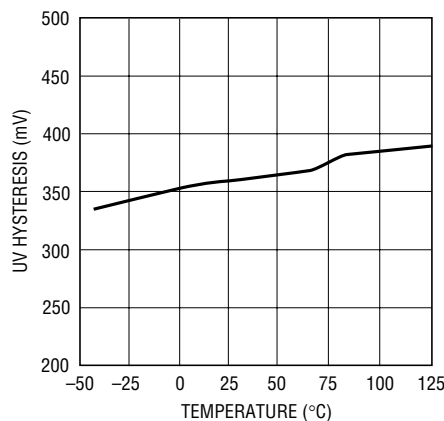
4254 G18

UV Threshold Voltage (Low-to-High) vs Temperature



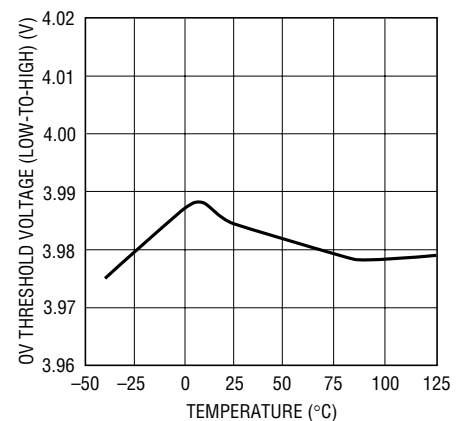
4254 G19

UV Hysteresis vs Temperature



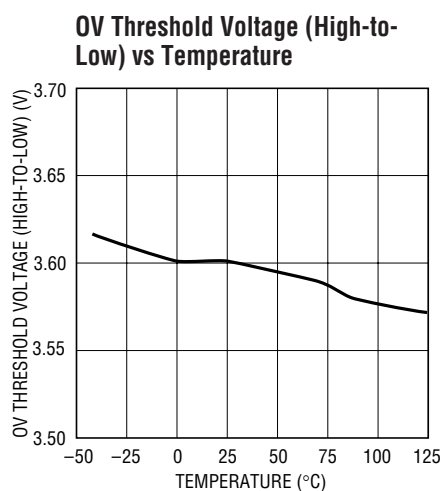
4254 G20

OV Threshold Voltage (Low-to-High) vs Temperature

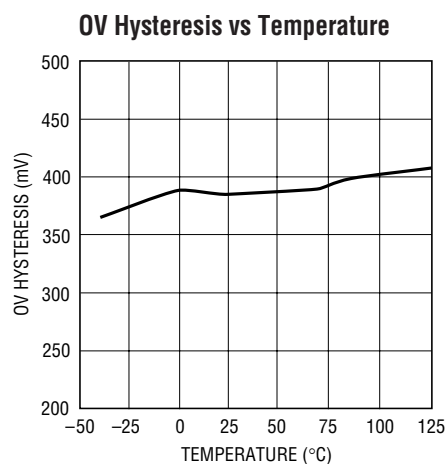


4257 G21

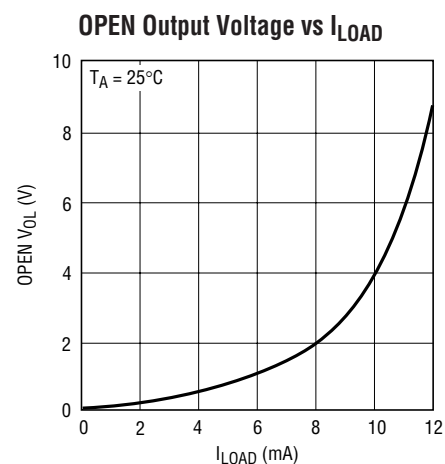
TYPICAL PERFORMANCE CHARACTERISTICS



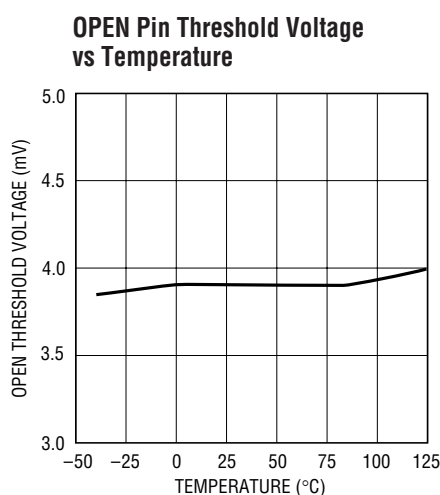
4254 G22



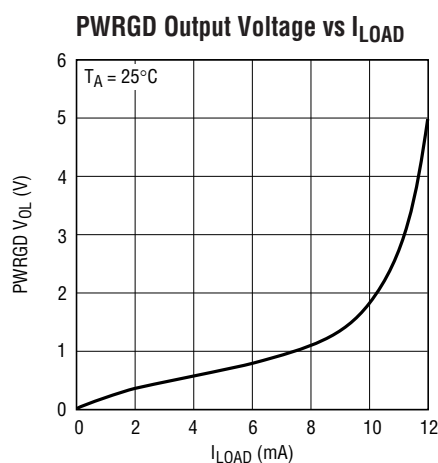
4254 G23



4254 G24



4254 G25



4254 G26

PIN FUNCTIONS

V_{CC} : Input Supply Voltage. The positive supply input ranges from 10.8V to 36V for normal operation. I_{CC} is typically 1.9mA. An internal circuit disables the LT4254 for inputs less than 9.8V (typ).

GND: Device Ground. This pin must be tied to a ground plane for best performance.

FB: Power Good Comparator Input. FB monitors the output voltage through an external resistive divider. When the voltage on the FB pin is lower than the high-to-low threshold of 4V, the PWRGD pin is pulled low and released

when the FB pin is pulled above the 4.45V low-to-high threshold.

The FB pin also affects foldback current limit (see Figure 7 and related discussion). To disable PWRGD monitoring, connect FB to the output voltage and float the PWRGD pin.

TIMER: Timing Input. An external timing capacitor from TIMER to GND programs the maximum time the part is allowed to remain in current limit. When the part goes into current limit, a 120 μ A pull-up current starts to charge the timing capacitor. When the voltage on the TIMER pin

PIN FUNCTIONS

reaches 4.65V (typ), the GATE pin is pulled low; the TIMER pull-up current will be turned off and the capacitor is discharged by a 3 μ A pull-down current. When the TIMER pin falls below 0.65V (typ), the GATE pin turns on again if the RETRY pin is high (if the RETRY pin is low, the UV pin must be pulsed low to reset the internal fault latch before the GATE pin will turn on). If the RETRY pin is grounded and the UV pin is not cycled low, the GATE pin remains latched off and the TIMER pin will be discharged near ground. The UV pin must be cycled low after the TIMER pin has discharged below 0.65V (typ) to reset the part.

If the RETRY pin is floating or connected to a voltage above its 1.2V threshold, the LT4254 automatically restarts after a current fault. Under an output short-circuit condition, the LT4254 cycles on and off with a 3% on-time duty cycle.

RETRY: Current Fault Retry. RETRY commands the operational mode of the current limit. If the RETRY pin is floating, the LT4254 automatically restarts after a current fault. If it is connected to a voltage below 0.4V, the part latches off after a current fault (which requires that the UV pin be cycled low in order to start normal operation again).

GATE: High Side Gate Drive for the External N-Channel MOSFET. An internal charge pump guarantees at least 10V of gate drive for V_{CC} supply voltages above 20V and 4.5V gate drive for V_{CC} supply voltages between 10.8V and 20V. The rising slope of the voltage on GATE is set by an external capacitor connected from the GATE pin to GND and an internal 35 μ A pull-up current source from the charge pump output.

If the current limit is reached, the GATE pin voltage is adjusted to maintain a constant voltage across the sense resistor while the timing capacitor starts to charge. If the TIMER pin voltage ever exceeds 4.65V, the GATE pin is pulled low.

The GATE pin is also pulled to GND whenever the UV pin is pulled low, or the V_{CC} supply voltage drops below the externally programmed undervoltage threshold or above the overvoltage threshold.

The GATE pin is clamped internally to a maximum voltage of 11V (typ) above V_{CC} under normal operating conditions.

Driving this pin beyond the clamp voltage may damage the part. A zener diode is needed between the gate and source of the external MOSFET to protect its gate oxide under instantaneous short-circuit conditions. See Applications Information.

SENSE: Current Limit Sense. A sense resistor is placed in the supply path between V_{CC} and SENSE. The current limit circuit regulates the voltage across the sense resistor ($V_{CC} - \text{SENSE}$) to 50mV while in current limit when FB is 2V or higher. If FB drops below 2V, the regulated voltage across the sense resistor decreases linearly and stops at 15mV when FB is 0V. The OPEN output also uses SENSE to detect when the output current is less than (3.5mV)/R5. To defeat current limit, connect SENSE to V_{CC} .

PWRGD: Open Collector Output to GND. PWRGD is pulled low whenever the voltage on FB falls below the high-to-low threshold voltage. It goes into a high impedance state when the voltage on FB exceeds the low-to-high threshold voltage. An external pull-up resistor can pull PWRGD to a voltage higher or lower than V_{CC} . To disable PWRGD, float this pin and connect FB to the output voltage.

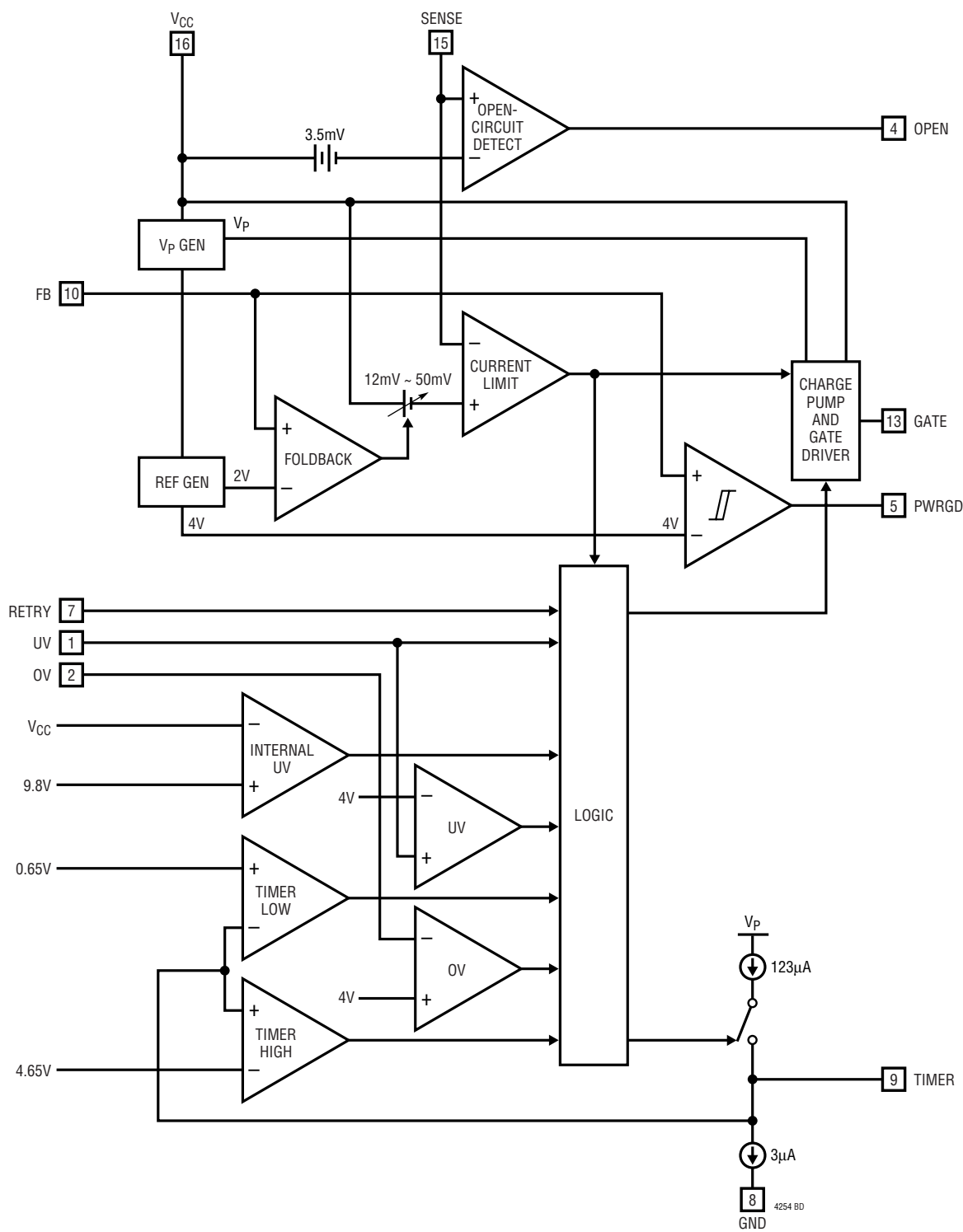
UV: Undervoltage Sense. UV is an input that enables the output voltage. When the UV pin is driven above 4V, the GATE pin starts charging and the output turns on. When the UV pin goes below 3.6V, the GATE pin discharges and the output shuts off.

Pulsing the UV pin to ground after a current limit fault cycle (TIMER pin discharged to below 0.65V typ) resets the fault latch (when RETRY pin is low, commanding latch off operation) and allows the part to turn back on. To disable UV sensing, connect the pin to V_{CC} through a 10k resistor.

OV: Overvoltage Sense. OV is an input that disables the output voltage. If OV ever goes above 4V, the GATE pin is discharged and the output shuts off. When OV goes below 3.6V, the GATE pin starts charging and the output turns back on. To disable OV sensing, connect pin to ground.

OPEN: Open Circuit Detect Output. This pin is an open collector output that releases and is pulled high through an external resistor if the load current is less than (3.5mV/R5). If not used, leave this pin disconnected.

BLOCK DIAGRAM



TEST CIRCUIT

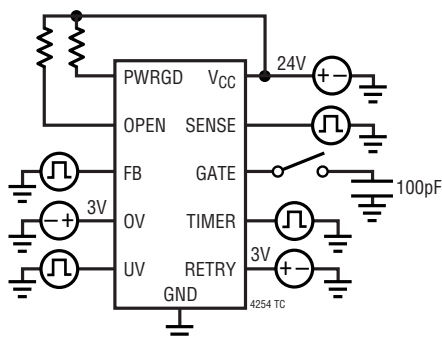


Figure 1

TIMING DIAGRAMS

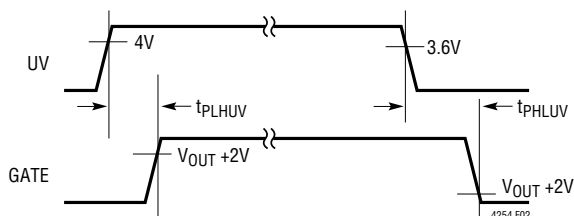


Figure 2. UV to GATE Timing

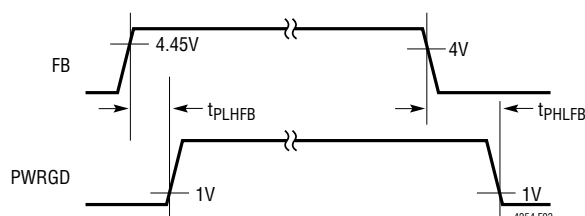
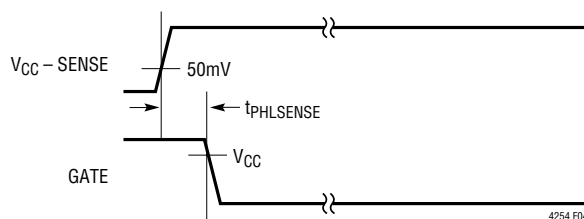
Figure 3. V_{OUT} to PWRGD Timing

Figure 4. SENSE to GATE Timing

APPLICATIONS INFORMATION

Hot Circuit Insertion

When circuit boards are inserted into a live backplane, the supply bypass capacitors on the boards draw high peak currents from the backplane power bus as they charge. The transient currents can permanently damage the connector pins and glitch the system supply, causing other boards in the system to reset.

The LT4254 is designed to turn on a board's supply voltage in a controlled manner, allowing the board to be safely inserted or removed from a live backplane. The

device also provides undervoltage and overvoltage as well as overcurrent protection while a power good output signal indicates when the output supply voltage is ready with a high output.

Power-Up Sequence

An external N-channel MOSFET pass transistor (Q1) is placed in the power path to control the power up of the supply voltage (Figure 5). Resistor R5 provides current detection and capacitor C1 controls the GATE slew rate.

4254fb

APPLICATIONS INFORMATION

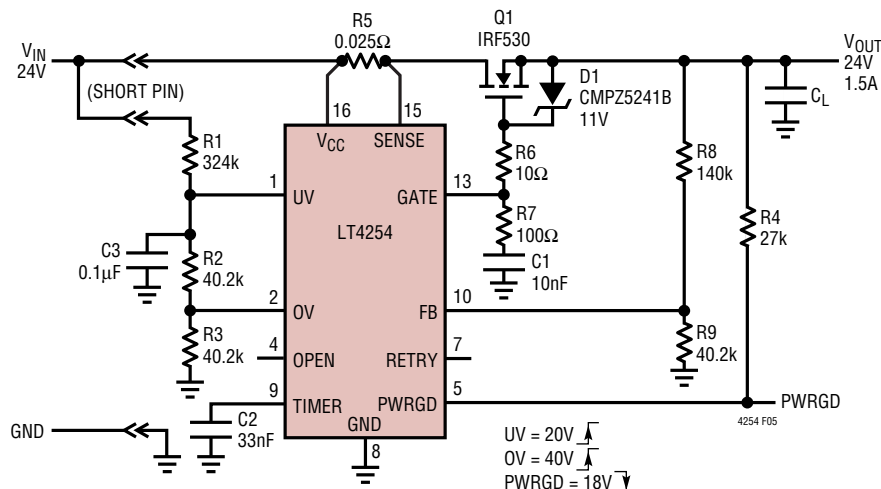


Figure 5. 2A, 24V Application

Resistor R7 compensates the current control loop while R6 prevents high frequency oscillations in Q1.

When the power pins first make contact, transistor Q1 is held off. If the voltage on the V_{CC} pin is between the externally programmed undervoltage and overvoltage thresholds, and the voltage on the TIMER pin is less than 4.65V (typ), transistor Q1 will be turned on (Figure 6). The voltage at the GATE pin rises with a slope equal to $35\mu\text{A}/C1$ and the supply inrush current is set at:

$$I_{\text{INRUSH}} = C_L \cdot 35\mu\text{A}/C1$$

If the voltage across the current sense resistor R5 reaches $V_{\text{SENSETRIP}}$, the inrush current will be limited by the internal current limit circuitry. The voltage on the GATE pin is adjusted to maintain a constant voltage across the sense resistor and the TIMER pin begins to charge.

When the FB pin voltage goes above the low-to-high V_{FB} threshold, the PWRGD pin goes high.

Short-Circuit Protection

The LT4254 features a programmable foldback current limit with an electronic circuit breaker that protects against short circuits or excessive load currents. The current limit is set by placing a sense resistor (R5) between V_{CC} and SENSE.

To limit excessive power dissipation in the pass transistor and to reduce voltage spikes on the input supply during short-circuit conditions at the output, the current folds

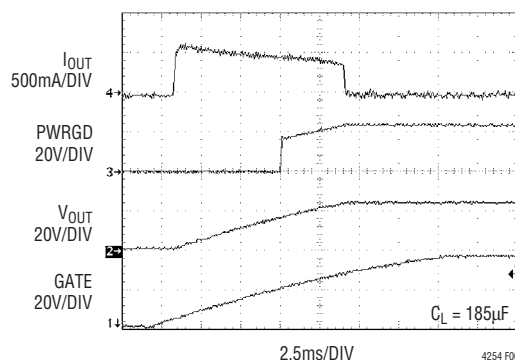


Figure 6. Start-Up Waveforms

back as a function of the output voltage, which is sensed internally on the FB pin.

When the voltage at the FB pin is 0V, the current limit circuit drives the GATE pin to force a constant 12mV drop across the sense resistor. As the output at the FB pin increases, the voltage across the sense resistor increases until the FB pin reaches 2V, at which point the voltage across the sense resistor is held constant at 50mV (see Figure 7). The current limit threshold is calculated as:

$$I_{\text{LIMIT}} = 50\text{mV}/R5$$

where R5 is the sense resistor.

For a 0.025Ω sense resistor, the current limit is set at 2000mA and folds back to 600mA when the output is shorted to ground. Thus, MOSFET dissipation under short-circuit conditions is reduced from 36W to 12W. See the

4254fb

APPLICATIONS INFORMATION

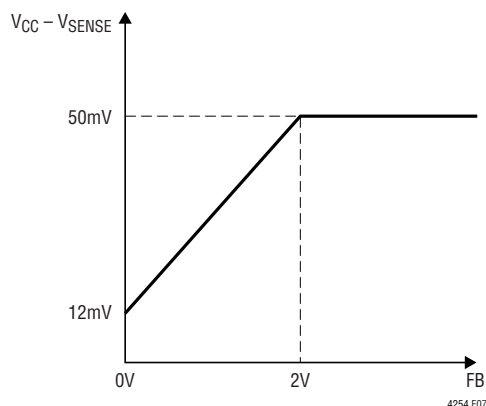


Figure 7. Current Limit Sense Voltage vs Feedback Pin Voltage

Layout Considerations section for important information about board layout to minimize current limit threshold error.

The LT4254 also features a variable overcurrent response time. The time required for the part to regulate the GATE pin voltage is a function of the voltage across the sense resistor connected between the V_{CC} pin and the SENSE pin. This helps to eliminate sensitivity to current spikes and transients that might otherwise unnecessarily trigger a current limit response and increase MOSFET dissipation. Figure 8 shows the response time as a function of the overdrive at the SENSE pin.

TIMER

The TIMER pin provides a method for programming the maximum time the part is allowed to operate in current limit. When the current limit circuitry is not active, the TIMER pin is pulled to GND by a $3\mu\text{A}$ current source. When the current limit circuitry becomes active, a $123\mu\text{A}$ pull-up current source is added to the TIMER pin and the voltage will rise with a slope equal to $120\mu\text{A}/C_{\text{TIMER}}$ as long as the circuitry stays active. Once the desired maximum current limit time is known, the capacitor value is:

$$C(\text{nF}) = 25.8 \cdot t(\text{ms})$$

Whenever the TIMER pin reaches 4.65V (typ), the internal fault latch is set causing the GATE to be pulled low and the TIMER pin to be discharged to GND by the $3\mu\text{A}$ current source. The part is not allowed to turn on again until the voltage at the TIMER pin falls below 0.65V (typ).

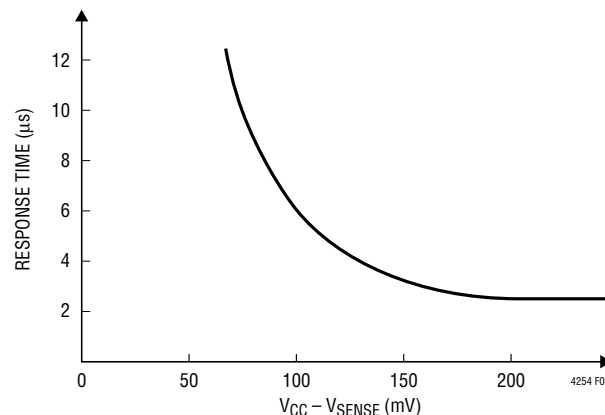


Figure 8. Response Time to Overcurrent

The TIMER pin must never be pulled high by a low impedance because whenever the TIMER pin voltage rises above the upper threshold (typically 4.65V) the pin characteristics change from a high impedance current source to a low impedance. If the pin must be pulled high by a logic signal, then a resistor must be put in series with the TIMER pin to limit the current to approximately $100\text{ }\mu\text{A}$. The resistance should be chosen as follows:

$$R_{\text{SERIES}} = (V_{\text{LOGIC}} - 4.65\text{V})/100\mu\text{A}$$

Whenever the GATE pin is commanded off by any fault condition, it is discharged with a high current, turning off the external MOSFET. The waveform in Figure 9 shows how the output latches off following a short-circuit. The drop across the sense resistor is held at 12mV as the timer ramps up. Since the output did not rise bringing FB above 2V and the current is still $12\text{mV}/R_S$, the circuit latches off.

Automatic Restart

If the RETRY pin is floating, then the functionality is as described in the previous section.

When the voltage at the TIMER pin ramps back down to 0.65V (typ), the LT4254 turns on again. If the short-circuit condition at the output still exists, the cycle will repeat itself indefinitely. The duty cycle under short-circuit conditions is 3% which prevents Q1 from overheating.

Latch Off Operation

If the RETRY pin is grounded, the LT4254 will latch off after a current fault. After the part latches off, it may be

APPLICATIONS INFORMATION

Latch Off Operation

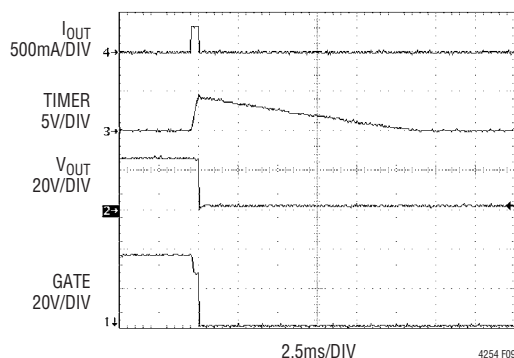


Figure 9. Latch Off Waveforms

commanded to start back up. This can be commanded by cycling the UV pin to ground and then back high (this command can only be accepted after the TIMER pin discharges below the 0.65V typ threshold, so as to prevent overheating transistor Q1).

Therefore, using the RETRY pin only, the LT4254 will either latch off after an overcurrent fault condition or it will go into a hiccup mode.

Undervoltage and Overvoltage Detection

The LT4254 uses the UV and OV pins to monitor the V_{CC} voltage and allow the user the greatest flexibility for setting the operational thresholds. The UV and OV pins are internally connected to an analog window comparator. Any time that the UV pin goes below 3.6V or the OV pin goes above 4V, the gate will be pulled low until the UV/OV pin voltages return to the normal operation voltage window (4V and 3.65V, respectively).

Power Good Detection

The LT4254 includes a comparator for monitoring the output voltage. The output voltage is sensed through the FB pin via an external resistor string. The comparator's output (PWRGD pin) is an open collector capable of operating from a pull-up as high as 36V.

The PWRGD pin can be used to directly enable/disable a power module with an active high enable input. Figure 11 shows how to use the PWRGD pin to control an active low enable input power module. Signal inversion is accomplished by transistor Q2 and R10.

Automatic Restart Operation (Short-Circuit Output)

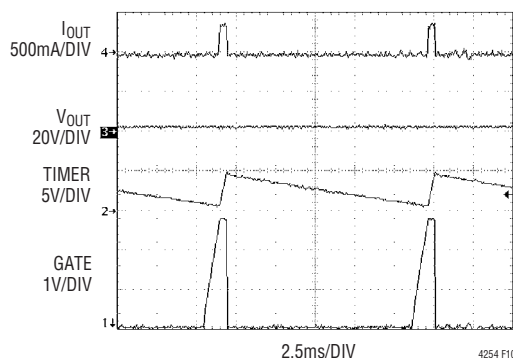


Figure 10. RETRY Waveforms

Open FET Detection

The LT4254 can be used to detect the presence of an open FET. When the voltage across the sense resistor is less than 3.5mV, the open collector pull-down device is shut off allowing the OPEN pin to be externally pulled high.

An open FET condition is signalled when the OPEN pin is high and the PWRGD pin is low (after the part has completed its start-up cycle). This open FET condition can be falsely signalled during start-up if the load is not activated until after PWRGD goes high. To avoid this false indication, the OPEN and PWRGD pins should not be polled for a period of time, $t_{STARTUP}$, given by:

$$\frac{3 \cdot V_{CC} \cdot C1}{35\mu A} = t_{STARTUP}$$

This can be accomplished either by a microcontroller (if available) or by placing an RC filter as shown in Figure 12.

Once the OPEN voltage exceeds the monitoring logic threshold, V_{THRESH} , and PWRGD is low, an open FET condition is signalled. In order to prevent a false indication, the RC product should be set with the following equation:

$$RC > \frac{3 \cdot V_{CC} \cdot C1}{35\mu A \left(\ln \left(\frac{V_{LOGIC}}{V_{LOGIC} - V_{THRESH}} \right) \right)}$$

Another condition that can cause a false indication is if the LT4254 goes into current limit during start-up. This will cause $t_{STARTUP}$ to be longer than calculated. Also, if the



Supply Transient Protection

suppressor (Transorb) at the input can also prevent damage from voltage transients.

GATE Pin

A curve of gate drive vs V_{CC} is shown in Figure 13. The GATE pin is clamped to a maximum voltage of 12V above the V_{CC} voltage. This clamp is designed to withstand the internal charge pump current. An external zener diode should be used if the possibility exists for an instantaneous low resistance short on V_{OUT} to occur. At a minimum input supply voltage of 12V, the minimum gate drive voltage is 4.5V. When the input supply voltage is higher than 20V, the gate drive voltage is at least 10V and a



Figure 13. ΔV_{GATE} vs V_{CC}

APPLICATIONS INFORMATION

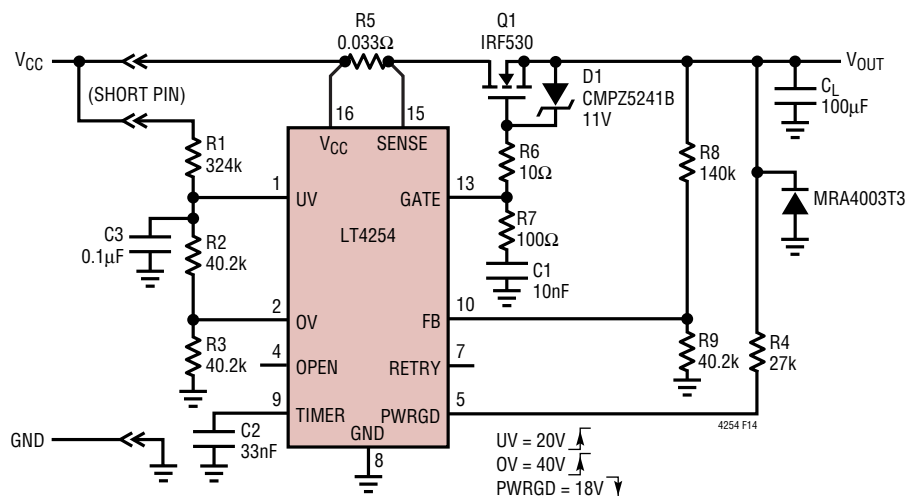


Figure 14. Negative Output Voltage Protection Diode Application

standard threshold MOSFET can be used. In applications from 12V to 15V range, a logic level MOSFET must be used.

In some applications it may be possible for the V_{OUT} pin to ring below ground (due to the parasitic trace inductance). Higher current applications, especially where the output load is physically far away from the LT4254 will be more susceptible to these transients. This is normal and the LT4254 has been designed to allow for some ringing below ground. However, if the application is such that V_{OUT} can ring more than 1V below ground, damage may occur to the LT4254 and an external diode from ground (anode) to V_{OUT} (cathode) will have to be added to the circuit as shown in Figure 14 (it is critical that the reverse breakdown voltage of the diode be higher than the highest expected V_{CC} voltage). A capacitor placed from ground to V_{OUT} directly at the LT4254 pins can help reduce the amount of ringing on V_{OUT} but it may not be enough for some applications.

During a fault condition, the LT4254 pulls down on the GATE pin with a switch capable of sinking about 55mA. Once the GATE voltage drops below the output voltage by a diode forward voltage, the external zener will forward bias and the output will also be discharged to GND. In addition to the GATE capacitance, the output capacitance will be discharged through the LT4254. In applications

that have very large output capacitors, this could cause damage to the LT4254. Therefore, the maximum output capacitance that can be used with the LT4254 is 1000 μ F.

In applications utilizing very large external N-channel MOSFETs, the possibility exists for the MOSFET to turn on when initially inserted into a live backplane (before the LT4254 becomes active and pulls down on GATE). This is due to the drain to gate capacitance forcing current into R7 and C1 when the drain voltage steps up from ground to V_{CC} with an extremely fast rise time. To alleviate this situation, a Schottky diode should be put across R7 with the cathode connected to C1 as shown in Figure 16.

Layout Considerations

To achieve accurate current sensing, a Kelvin connection to the current sense resistor (R5 in typical application circuit) is recommended. The minimum trace width for 1oz copper foil is 0.02" per amp to make sure the trace stays at a reasonable temperature. 0.03" per amp or wider is recommended. Note that 1oz copper exhibits a sheet resistance of about $530\mu\Omega/\square$. Small resistances can cause large errors in high current applications. Noise immunity will be improved significantly by locating resistor dividers close to the pins with short V_{CC} and GND traces. A 0.1 μ F decoupling capacitor from UV to GND is also required. Figure 15 shows a layout that meets these requirements.

APPLICATIONS INFORMATION

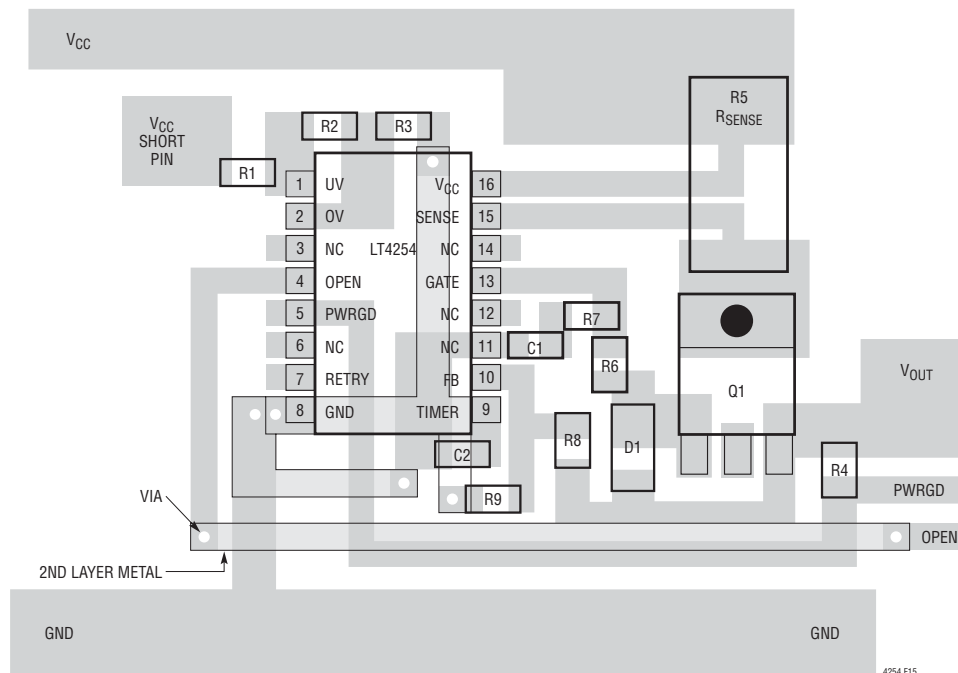
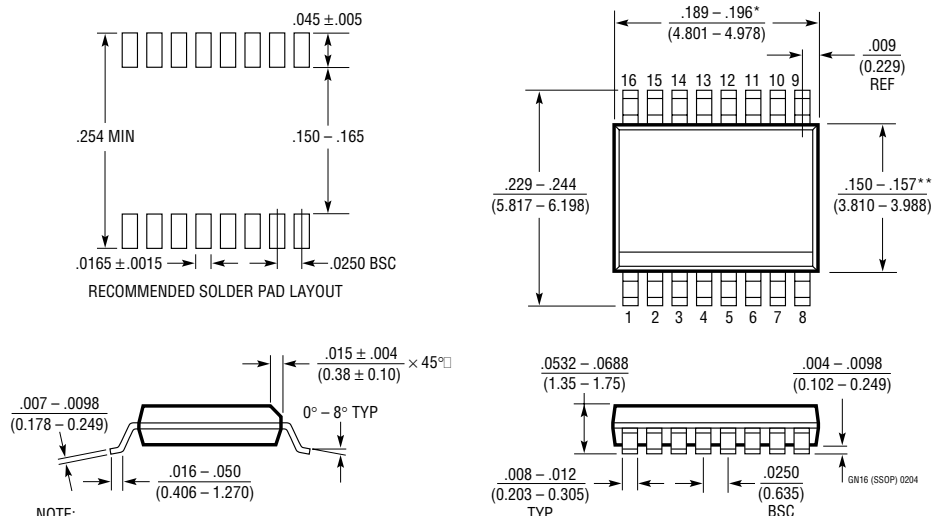


Figure 15. Recommended Component Placement

PACKAGE DESCRIPTION

GN Package 16-Lead Plastic SSOP (Narrow .150 Inch) (Reference LTC DWG # 05-08-1641)



NOTE:

1. CONTROLLING DIMENSION: INCHES

2. DIMENSIONS ARE IN INCHES
(MILLIMETERS)

3. DRAWING NOT TO SCALE

*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH
SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

**DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD
FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE

TYPICAL APPLICATION

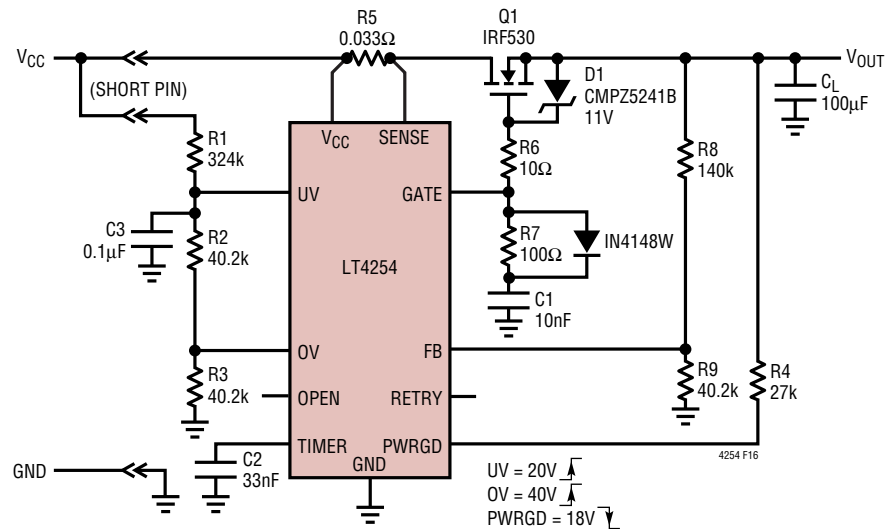


Figure 16. High dV/dT MOSFET Turn-On Protection Circuit

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1641-1/LT1641-2	Positive 48V Hot Swap Controller in SO-8	9V to 80V Operation, Active Current Limit, Autoretry/Latchoff
LTC4211	Single Hot Swap Controller with Multifunction Current Control	2.5V to 16.5V, Active Inrush Limiting, Dual Level Circuit Breaker
LTC4251	Negative 48V Hot Swap Controller in SOT-23	Floating Supply from –15V, Active Current Limiting, Fast Circuit Breaker
LT4252-1/LTC4252-2	Negative 48V Hot Swap Controller in MSOP	Floating Supply from –15V, Active Current Limiting, Power Good Output
LTC4253	Negative 48V Hot Swap Controller and Supply Sequencer	Floating Supply from –15V, Active Current Limiting, Enables Three DC/DC Converters
LT4256-1	Positive 48V Hot Swap Controller in SO-8	10.8 to 80V Operation, Latch-Off Operation, Improved LT1641-1
LT4256-2	Positive 48V Hot Swap Controller in SO-8	10.8 to 80V Operation, Auto Retry Operation, Improved LT1641-2
LT4256-3	Positive 48V Hot Swap Controller in GN-16	10.8 to 80V Operation, Open Circuit Detect, Selectable Latch-Off or Auto Retry
LTC4260	Positive 48V Hot Swap Controller with I ² C Monitoring	Onboard 8-Bit ADC with I ² C Interface for Board Monitoring
LTC4261	Negative 48V Hot Swap Controller with I ² C Monitoring	Onboard 10-Bit ADC with I ² C Interface for Board Monitoring